Supplier Name: SPIL
Company Address: 417 Oakbend Dr. #130, Lewisville TX 75067
Responder Contact Name: Joe Kuo
Responder Contact Phone: 972.459.2333 x105
Responder Contact email: JimK@spilca.com
Responder Title: Package Application Engineer

Date of Response: 10/30/2008

Responder Signature:

Instructions

Suppliers must provide the identity and % weight of flame retardant substances listed below present in materials used in products supplied to Maxim.

Data is to supplied for each material type/formulation used in our products. Where multiple suppliers are used, worse case data (highest value) should be shown. Examples: Material Type = Mold Compound, Name/Formula = Sumitomo EME-G600. Material Type =

Where there is no content of the substance, enter 0%.
Insert additional rows as needed to reflect content of substances per material used.

		% Weight of Substance/CAS number																					
	VSC7157YS	Antimony Trioxide/CAS# 1309-64-4	Red Phosphorous/CAS # 7723-14-0	Phosphorous/CAS # 7723-14-0	TPP (Triphenyl Phosphate)/CAS# 115-86-6	Poly Vinyl Chloride (PVC)/CAS# 9002-86-2	Polychlorinated dibenzofurans/CAS# 42934-53-2	Polybrominated Dibenzofurans/CAS# 86-76-0	Vinyl Chloride/CAS# 75-01-4	Poly Aromatic Hydrocarbons (PAH)/CAS# 26140-60-3	Pentachlorophenol (PCP)/CAS# 87-86-5	Hexachlorocyclohexane (HCH)/CAS# 608-73-1, 6108-11-8	Monomethyltetrachloro Diphenyl Methane (CAS# 76253-60-6)	Monomethyldichloro Diphenyl Methane (CAS# 81161-70-8)	Monomethyldibromo Diphenyl Methane (CAS# 99788-47-8)	EPS (Expanded Polystyrene)/CAS# 9003-70-7							
Material Type	Die Attached																						
Material Name/Formula	Hitachi EN4900	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Fill																						
Material Name/Formula	LOCTITE FP4800	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Dam																						
Material Name/Formula	LOCTITE FP4451	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Wire																						
Material Name/Formula	SMM 1.0 MIL	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Solder Ball																						
Material Name/Formula	SENJU Sn63/Pb37	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Substrate																						
Material Name/Formula	KINSUS 1B07951	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	HS																						
Material Name/Formula	KINSUS Cu	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							
Material Type	Ink marking																						
Material Name/Formula	MARKEM 4461	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%							